PD-96005B

International

IRC640PbF

 $V_{DSS} = 200V$

 $I_{\rm D} = 18A$

 $R_{DS(on)} = 0.18\Omega$

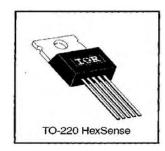
HEXFET[®] Power MOSFET

- · Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Current Sense
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The HEXSense device provides an accurate fraction of the drain current through the additional two leads to be used for control or protection of the device. These devices exhibit similar electrical and thermal characteristics as their IRF-series equivalent part numbers. The provision of a kelvin source connection effectively eliminates problems of common source inductance when the HEXSense is used as a fast, high-current switch in non current-sensing applications.



Absolute Maximum Ratings

	Parameter	Max.	Units
ID @ Tc = 25°C	18		
$I_D @ T_C \simeq 100^{\circ}C$	Continuous Drain Current, VGS @ 10 V	11	A
IDM	Pulsed Drain Current ①	72	
$P_D @ T_C = 25^{\circ}C$	Power Dissipation	125	W
	Linear Derating Factor	1.0	W/°C
V _{GS}	Gate-to-Source Voltage	±20	V
Eas	Single Pulse Avalanche Energy @	430	mJ
IAR	Avalanche Current ①	18	A
EAR	Repetitive Avalanche Energy ①	13	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting Torque, 6-32 or M3 screw	10 lbf+in (1.1 N+m)	

٩D

S

G

Kelvin

Source

Current

Sense

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
Rejc .	Junction-to-Case	-	-	1.0	
Rocs	Case-to-Sink, Flat, Greased Surface	—	0.50	-	°C/W
Reja	Junction-to-Ambient	-	_	62	

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	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	200	-	-	V	V _{GS} =0V, I _D = 250µA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.29	-	V/ºC	Reference to 25°C, ID= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	-		0.18	Ω	V _{GS} =10V, I _D =11A @	
V _{GS(th)}	Gate Threshold Voltage	2.0	-	4.0	V	V _{DS} =V _{GS} , I _D = 250µA	
g fs	Forward Transconductance	6.5	-	-	S	VDS=50V, ID=11A @	
loss	Drain-to-Source Leakage Current	_	-	25	μA	V _{DS} =200V, V _{GS} =0V	
IDSS	Drain-10-Source Leakage Current	-	-	250	μΑ	VDS=160V, VGS=0V, TJ=125°C	
1	Gate-to-Source Forward Leakage		-	100	nA	V _{GS} =20V	
lgss	Gate-to-Source Reverse Leakage		-	-100	Inc	V _{GS} =-20V	
Qg	Total Gate Charge	-	-	70		ID=18A	
Qgs	Gate-to-Source Charge		-	13	nC	V _{DS} =160V	
Q _{gd}	Gate-to-Drain ("Miller") Charge	-	-	39		V _{GS} =10V @	
t _{d(on)}	Turn-On Delay Time	-	14	-		V _{DD} =100V	
tr	Rise Time	-	51		ns	ID=18A	
td(off)	Turn-Off Delay Time	-	45	-	115	R _G =9.1Ω	
tr	Fall Time	-	36	-		R _D =3.2Ω ④	
Lo	Internal Drain Inductance	-	4.5	-	nH	Between lead, 6 mm (0.25in.) from package and center of die contact	
Ls	Internal Source Inductance	-	7.5	-			
Ciss	Input Capacitance	-	1300	-		V _{GS} =0V	
Coss	Output Capacitance	-	430	-	pF	V _{DS} = 25V	
Crss	Reverse Transfer Capacitance	-	130	-		f=1.0MHz	
r	Current Sensing Ratio	2600	-	2880	-	ID=18A, VGS=10V	
Coss	Output Capacitance of Sensing Cells		9.0	-	pF	VGS=0V, VDS= 25V, f=1.0MHz	

Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
ls	Continuous Source Current (Body Diode)	-	-	18	A	MOSFET symbol showing the	
ISM	Pulsed Source Current (Body Diode) ①	-	-	72		p-n junction diode.	
VsD	Diode Forward Voltage	-	-	2.0	V	Tj=25°C, Is=18A, Vgs=0V @	
trr	Reverse Recovery Time	_	300	610	ns	T_=25°C, I==18A	
Qrr	Reverse Recovery Charge	-	3.4	7.1	μC	di/dt=100A/µs ④	
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)					

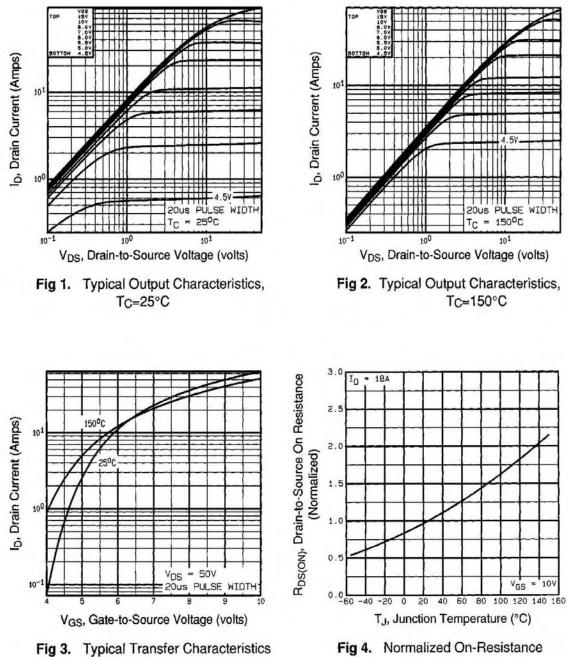
Notes:

- Repetitive rating; pulse width limited by max. junction temperature
- ③ I_{SD}≤18A, di/dt≤150A/µs, V_{DD}≤V_{(BR)DSS}, T_J≤150°C
- ② V_{DD}=50V, starting T_J=25°C, L=2.0mH R_G=25Ω, I_{AS}=18A
- ④ Pulse width \leq 300 µs; duty cycle \leq 2%.

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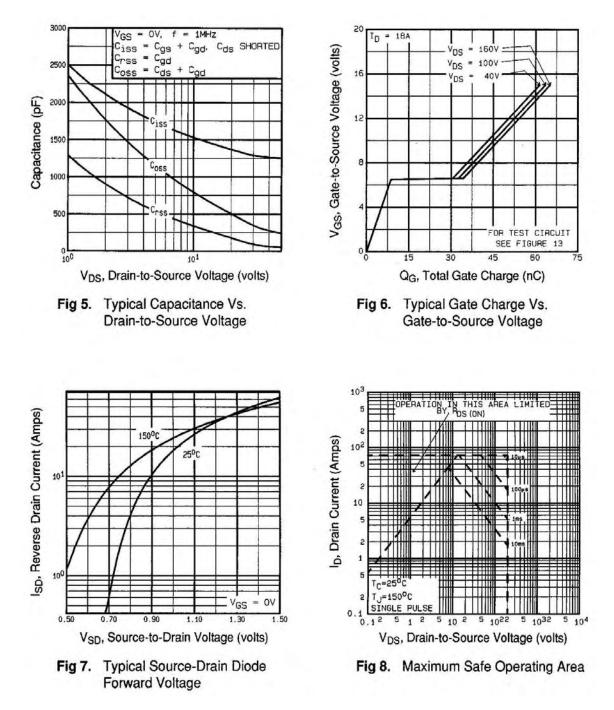
International



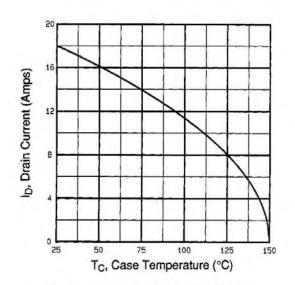
Vs. Temperature

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International

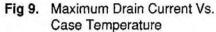


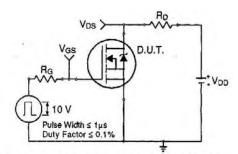
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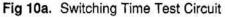


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ICR Rectifier







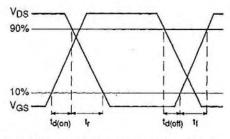


Fig 10b. Switching Time Waveforms

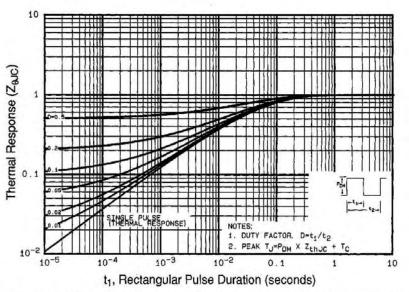


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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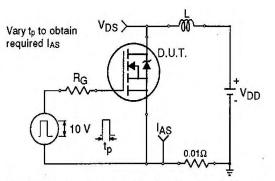


Fig 12a. Unclamped Inductive Test Circuit

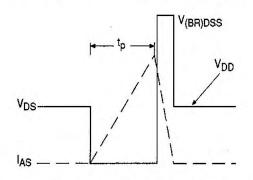


Fig 12b. Unclamped Inductive Waveforms

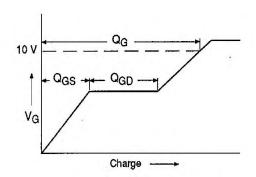
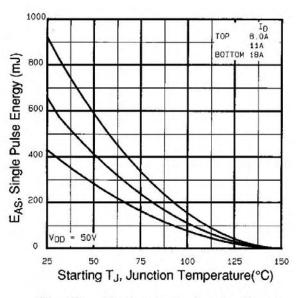
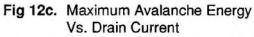


Fig 13a. Basic Gate Charge Waveform





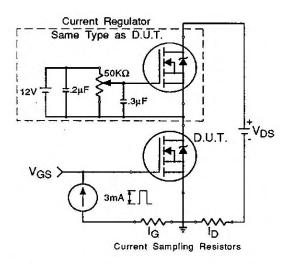


Fig 13b. Gate Charge Test Circuit

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International

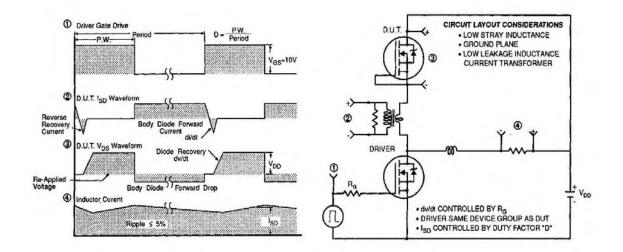
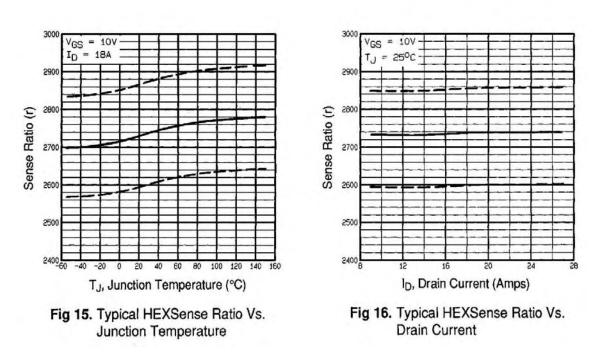


Fig 14. Peak Diode Recovery dv/dt Test Circuit



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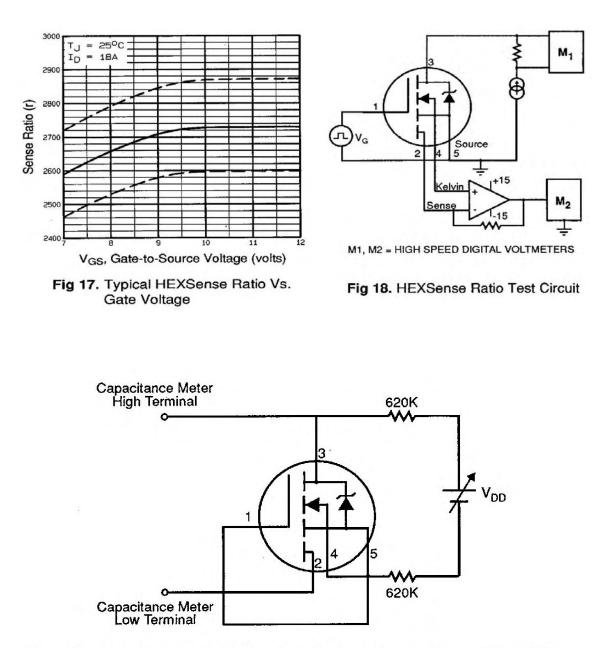


Fig 19. HEXSense Sensing Cell Output Capacitance Test Circuit

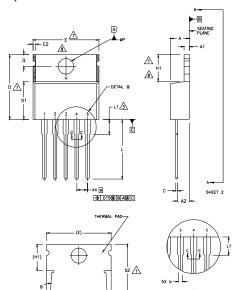
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International **TOR** Rectifier

IRC640PbF

HexsenseTO-220 5L Package Outline

(Dimensions are shown in millimeters (inches)



A

NOTES: DIMENSIONING AND TOLERANCING PER ASME Y14,5 M- 1994.

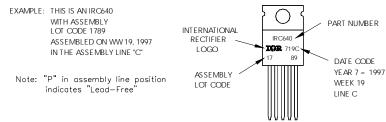
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- DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. DIMENSIONS ARE SHOWN IN INCHES MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1. DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED. 005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. DIMENSION 1 & c1 APPLY TO BASE METAL ONLY. CONTROLLING DIMENSION : INCHES. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,1,1,D2 & E1 DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED.

SYMBOL	MILLIM	MILLIMETERS INCHES			
	Min.	MAX.	MIN.	MAX.	NOTES
A	3.56	4.82	.140	.190	
A1	0.51	1.40	.020	.055	
A2	2.04	2.92	.080	.115	
b	0.64	0.88	.025	.035	
b1	0.64	0.84	.025	.033	5
с	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16,51	.560	.650	4
D1	8.38	9.02	.330	.355	
D2	12.19	12.88	.480	.507	7
E	9.66	10.66	.380	.420	4,7
E1	8,38	8.89	.330	.350 BSC	7
е	1.70	BSC	.067		
H1	5.85	6,55	.230	.270	7,8
L	13.47	14,09	.530	.555	
L1	-	6,35	-	.250	3
øP	3.54	4.08	.139	.161	
Q	2,54	3.42	.100	.135	
ø	90'-	-93*	90'-	-93'	
			[
			[
			[

Hexsense TO-220 5L Part Marking Information

C & 0-0



Data and specifications subject to change without notice.

International **ICR** Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 02/05

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